SPECIFICATION

SPEC. No. A-Glue-a

D A T E: 2013 Sep.

To

Non-Controlled Copy

CUSTOMER'S PRODUCT NAME TDK PRODUCT NAME

MULTILAYER CERAMIC CHIP CAPACITORS

CGA Series / Automotive Grade Conductive Epoxy Application

Please return this specification to TDK representatives.

If orders are placed without returned specification, please allow us to judge that specification is accepted by your side.

RECEIPT CONFIRMATION

DATE: YEAR MONTH DAY

TDK Corporation
Sales
Electronic Components
Sales & Marketing Group

TDK-EPC Corporation

Engineering

Ceramic Capacitors Business Group

APPROVED	Person in charge

APPROVED	CHECKED	Person in charge

1. SCOPE

This specification is applicable to chip type multilayer ceramic capacitors with a priority over the other relevant specifications.

Production places defined in this specification shall be TDK-EPC Corporation Japan, TDK(Suzhou)Co.,Ltd and TDK Components U.S.A. Inc.

EXPLANATORY NOTE:

This specification warrants the quality of the ceramic chip capacitors. The chips should be evaluated or confirmed a state of mounted on your product.

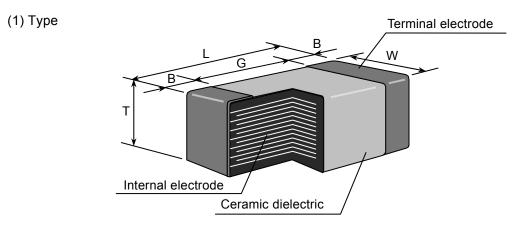
If the use of the chips goes beyond the bounds of the specification, we can not afford to guarantee.

2. CODE CONSTRUCTION

(Example)

 Catalog Number :
 CGA4 (Web)
 J (2)
 3 (3)
 X7R (4)
 1E (5)
 105 (6)
 K (7)
 125 (8)
 A (9)
 D (10)

 Item Description :
 CGA4 (J)
 3 (3)
 X7R (1E)
 105 (K)
 K (T)
 *** B



Please refer to product list for the dimension of each product.

(2) Thickness

* As for dimension tolerance, please contact with our sales representative.

Ihickness	Dimension(mm)
В	0.50
С	0.60
Е	0.80
F	0.85
Н	1.15
J	1.25
L	1.60
М	2.00
Р	2.50

(3) Voltage condition in the life test (Max. Operating Temp./1000h)

Sign	Condition
1	Rated Voltage x 1
2	Rated Voltage x 2
3	Rated Voltage x 1.5



(4) Temperature Characteristics (Details are shown in table 1 No.7 and No.8 at page 5)

(5) Rated Voltage

Symbol	Rated Voltage
2 A	DC 100 V
1 H	DC 50 V
1 V	DC 35 V
1 E	DC 25 V
1 C	DC 16 V
0 J	DC 6.3 V

(6) Rated Capacitance

Stated in three digits and in units of pico farads (pF).

The first and Second digits identify the first and second significant figures of the capacitance, the third digit identifies the multiplier.

R is designated for a decimal point.

$$\begin{array}{ccc} \text{Example 2R2} & \rightarrow & \text{2.2pF} \\ & \text{105} & \rightarrow & \text{1,000,000pF} \end{array}$$

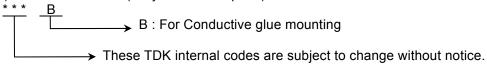
(7) Capacitance tolerance

Symbol	Tolerance	Capacitance
С	± 0.25 pF	10pF and under
D	± 0.5 pF	Topr and under
J	± 5%	
K	± 10 %	Over 10 pF
М	± 20 %	

- (8) Thickness code (Only Catalog Number)
- (9) Package code (Only Catalog Number)
- (10) Special code (Only Catalog Number)
- (11) Packaging (Only Item Description)
 (Bulk is not applicable for CGA2 type.)

Symbol	Packaging
В	Bulk
Т	Taping

(12) TDK Internal code (Only Item Description)





3. RATED CAPACITANCE AND CAPACITANCE TOLERANCE

3.1 Standard combination of rated capacitance and tolerances

Class	Temperature Characteristics	Capacitar	nce tolerance	Rated capacitance
	COG	10pF and	C (±0.25pF)	1, 1.5, 2, 2.2, 3, 3.3, 4, 4.7, 5
1		under	D (±0.5pF)	6, 6.8, 7, 8, 9, 10
		Over 10pF	J (± 5 %) K (± 10 %)	E – 12 series
2	X7R X8R		(± 10 %) (± 20 %)	E – 6 series

3.2 Capacitance Step in E series

E series	Capacitance Step											
E- 6	1.	1.0 1.5 2.2 3.3			4.	7	6.	.8				
E-12	1.0	1.2	1.5	1.8	2.2	2.7	3.3	3.9	4.7	5.6	6.8	8.2

4. OPERATING TEMPERATURE RANGE

T.C.	Min. operating Temperature	Max. operating Temperature	Reference Temperature		
C0G	-55°C	125°C	25°C		
X7R	-55°C	125°C	25°C		
X8R	-55°C	150°C	25°C		

5. STORING CONDITION AND TERM

5 to 40°C at 20 to 70%RH

6 months Max.

6. INDUSTRIAL WASTE DISPOSAL

Dispose this product as industrial waste in accordance with the industrial Waste Law.

7. MEASURES FOR CORROSIVE GAS

In order to avoid the failures which are caused by corrosive gas, chip capacitors must be sealed with silicon resin or equivalent.

8. PERFORMANCE

table 1

No.	Item	Perfori	mance	Test or inspection method					
1	External Appearance	No defects which performance.	Inspect with magnifying glass (3×).						
2	Insulation Resistance	10,000M Ω or 500N (As for the capacity voltage 16, 10 and M Ω or 100M Ω ·μF whichever smaller	tors of rated d 6.3V DC, 10,000 min.,)	Apply rated voltage for 60s.					
3	Voltage Proof	Withstand test vol	tage without						
		insulation breakdo	own or other	Cla			Apply volta		
		damage.		Clas			× rated vo		
				Class2 2.5 × rated voltage Above DC voltage shall be applied for 1 to 5s. Charge / discharge current shall not exceed 50mA.					
4	Capacitance	Within the specifie		1					
			Class	Rated Capacitar		Measuring frequency	Measuring voltage		
			Class1	1000pF unde	r	1MHz±10%	0.5-5 Vrms.		
					Over 100	0pF	1kHz±10%		
				Class2	10uF ar under		1kHz±10%	0.5±0.2Vms. 1.0±0.2Vms.	
5	Q			measurii sales rep	ng voltag oresenta	ge, p		act with our	
	(Class1)	Rated Capacitance	Q	condition				3	
	,	30pF and over	1,000 min.						
		Under 30pF	400+20×C min.						
		C : Rated capacita							
6	Dissipation Factor	T.C.	D.F.			table	e for measu	uring	
	(Class2)			condition	1.				
		X7R X8R	0.03 max. 0.05 max. 0.075 max. 0.1 max.				h product h lease conta	as which act with our	



No.	Item		Performance	Te	est or inspection method			
7	Temperature Characteristics of Capacitance (Class1)		Temperature Coefficient (ppm/°C) 0 ± 30 nce drift within ± 0.2% or whichever larger.	Temperature coefficient shall be calculated based on values at 25°C and 85°C temperature. Measuring temperature below 20°C shall be -10°C and -25°C.				
8	Temperature Characteristics of Capacitance (Class2)	Capacitance Change (%) No voltage applied X7R: ±15 X8R: ±15		Capacitance shall be measured by the steps shown in the following table after thermal equilibrium is obtained for each step. ΔC be calculated ref. STEP3 reading Step Temperature(°C) 1 Reference temp. ± 2 2 Min. operating temp. ± 2 3 Reference temp. ± 2 4 Max. operating temp. ± 2 Measuring voltage As for the capacitor of rated voltage 10V DC(1A) and 6.3V DC(0J), 0.1Vrms shall be applied. For information which product has which				
9	Robustness of Terminations	_	of termination coming off, e of ceramic, or other I signs.	Mount the substrate conductiv force of 5 (2N is app	e capacitors on an Alumina shown in Appendix 1 with e glue and apply a pushing N with 10±1s. Dilicable for CGA2 type) Pushing force Alumina substrate			

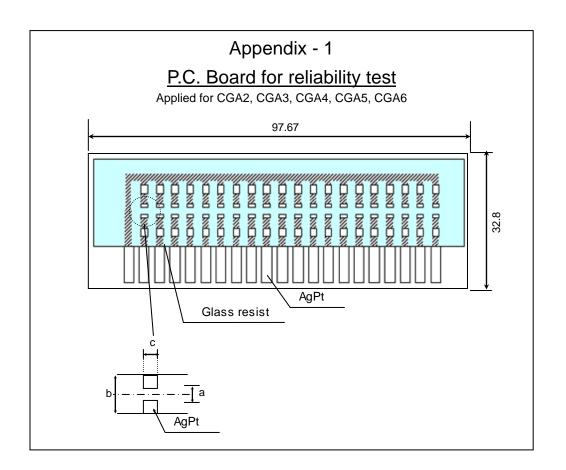
No.	Ite	em	Performance			ince		Test or inspection n	nethod
10	Vibration	External appearance	No mechanical damage.			Mount the capacitors on an Alumina substrate shown in Appendix 1 with			
		Capacitance	Charact	eristics		ange from the	condu	ctive glue before tes	ing.
			Class1	COG	±2.5	we before test % or ±0.25pF,	Vibrate conditi	e the capacitor with fons.	ollowing
			Class2	X7R X8R	Wnic	± 7.5 %	Applie	d force : 5G max.	
								ency : 10-2000Hz on : 20 min.	
		Q					Cycle:	12 cycles in each 3	mutually
		(Class1)		apacitano		Q	perpen	dicular directions.	
				and over		1,000 min.			
			Unde	er 30pF	4	400+20×C min.			
			C : Rate	d capa	citan	ce (pF)			
		D.F.	Meet the initial spec.						
		(Class2)							
11	Temperature	External	No mechanical damage.			age.	Mount the capacitors on an Alumina substrate shown in Appendix 1 with		
	cycle	appearance							
		Capacitance			conductive glue before testing.				
			Charact	eristics	Change from the value before test		Expose the capacitors in the condition		
			Class1	C0G		% or ±0.25pF, chever larger.	step1 through step 4 and repeat 1,0 times consecutively.	epeat 1,000	
			Class2 X7R ± 7.5 % X8R ± 12.5 %						
					Leave the capacitors in ambient				
		Q					condition for 6 to 24h (Class 1) or		s 1) or
		(Class1)	Rated Capacitance (Q	24±2h (Class 2) before measurem		asurement.	
			30pF	and over		1,000 min.	Step	Temperature(°C)	Time (min.
			Unde C : Rate	er30pF d capa		400+20×C min. ce (pF)	1	Min. operating temp. ±3	30 ± 3
		D.F.	Meet the	initial	enoo	· 		Reference Temp.	2 - 5
		(Class2)			•		3	Max. operating	30 ± 2
		Insulation Resistance	Meet the	initial	spec	. .	-	temp. ±2	
		Voltage proof	No insula		reak	down or	4	Reference Temp.	2 - 5

No.	Item Moisture External		Perfor	mance	Test or inspection method	
12	Moisture Resistance	External appearance	No mechanical da	amage.	Mount the capacitors on an Alumina substrate shown in Appendix 1 with	
	(Steady State)	Capacitance		Change from the value before test	conductive glue before testing. Leave at temperature 40±2°C, 90 to 95%RH for 500 +24,0h. Leave the capacitors in ambient condition for 6 to 24h (Class1) or	
		Q (Class1)	Rated Capacitance 30pF and over	Q 350 min.	24±2h (Class2) before measurement.	
			10pF and over under 30pF Under 10pF C: Rated capacit	275+5/2×C min. 200+10×C min. tance (pF)		
		D.F. (Class2)	Characteristics 200% of initial sp	. ,		
		Insulation Resistance	1,000M Ω or 50M Ω · (As for the capac voltage 16, 10 an M Ω or 10M Ω ·μF whichever smalle	itors of rated ad 6.3V DC, 1,000 min.,)		
3	Moisture Resistance	External appearanc e	No mechanical da	amage.	Mount the capacitors on an Alumina substrate shown in Appendix 1 with conductive glue before testing.	
		Capacitance	Change from the value before test		Apply the rated voltage at temperature 85°C and 85%RH for 1,000 +48,0h.	
		Q (Class1)	1 (1266.1 (116-1	7.5% or ±0.75pF, vhichever larger. ± 12.5 % ± 25 %	Charge/discharge current shall not exceed 50mA.	
			Rated Capacitance 30pF and over	Q 200 min.	Leave the capacitors in ambient condition for 6 to 24h (Class1) or 24±2h (Class2) before measurement. Voltage conditioning (only for class2)	
			Under 30pF C: Rated capacit	100+10/3×C min. tance (pF)	Voltage treat the capacitor under testing temperature and voltage for 1hour.	
		D.F. (Class2)	Characteristics 200% of initial sp	oec. max.	Leave the capacitors in ambient condition for 24±2h before measurement. Use this measurement for initial	
		Insulation Resistance	500 M Ω or 25 M Ω · (As for the capac voltage 16, 10 an M Ω or 5 M Ω ·μF m whichever smalle	itors of rated ad 6.3V DC, 500 nin.,)	value.	



No.	l1	tem		Perf	ormance	Test or inspection method	
14	Life	External appearance	No mechanical damage.			Mount the capacitors on an Alumina substrate shown in Appendix 1 with conductive glue before testing.	
		Capacitance	before test		Change from the value before test ±3% or ±0.3pF,	Below the voltage shall be applied at maximum operating temperature ±2°C for 1,000 +48, 0h.	
			Class1	C0G	whichever larger.	Applied voltage	
			Class2	X7R X8R	± 15 % ± 25 %	Rated voltage x2	
				XOIX	1 23 /0	Rated voltage x1.5	
						Rated voltage x1	
		Q (Class1)	Rated Capacitano		œ Q	For information which product has	
			30pF and over 10pF and over under 30pF Under 10pF			which applied voltage, please contact	
					275+5/2×C min.	with our sales representative.	
					200+10×C min.	Charge/discharge current shall not exceed 50mA.	
			C : Rated capacitance (pF)			exceed 50mA.	
		D.F. (Class2)	Characte 200% o		spec. max.	Leave the capacitors in ambient condition for 6 to 24h (Class1) or 24±2h (Class2) before measurement.	
		Insulation Resistance	1,000M Ω or 50M Ω ·μF min. (As for the capacitors of rated voltage 16, 10 and 6.3V DC, 1,000 M Ω or 10M Ω ·μF min.,) whichever smaller.			Voltage conditioning (only for class2) Voltage treat the capacitor under testing temperature and voltage for 1hour. Leave the capacitors in ambient condition for 24±2h before measurement. Use this measurement for initial value.	

^{*}As for the initial measurement of capacitors (Class2) on number 8,10,11 and 12, leave capacitors at 150 -10,0°C for 1 hour and measure the value after leaving capacitors for 24±2h in ambient condition.



Material: Alumina substrate

Alumina substrate thickness: Appendix-1 0.8mm

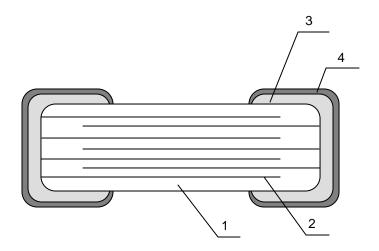
AgPt
Glass resist

Caution for mounting with conductive glue (Refer to the page 12.)

TDI/ (FIA atria)	Dimensions (mm)				
TDK (EIA style)	а	b	С		
CGA2 (CC0402)	0.5	1.4	0.5		
CGA3 (CC0603)	0.9	2.7	1.2		
CGA4 (CC0805)	0.9	2.7	1.9		
CGA5 (CC1206)	1.8	4.0	2.0		
CGA6 (CC1210)	1.8	4.4	3.0		



9. INSIDE STRUCTURE AND MATERIAL



No.	NAME	MATERIAL			
NO.	INAIVIE	Class1	Class2		
1	Dielectric	CaZrO ₃	BaTiO₃		
2	Electrode	Nicke	l (Ni)		
3	Tarmination	Copper (Cu)			
4	Termination	AgPdCu			

10. Caution

10.	Caution					
No.	Process	Condition				
1	Operating Condition (Storage,	 Storage The capacitors must be stored in an ambient temperature of 5 to 40°C with a relative humidity of 20 to 70%RH. The products should be used within 6 months upon receipt. 				
	Transportation)	2) The capacitors must be operated and stored in an environment free of dew condensation and these gases such as Hydrogen Sulphide, Hydrogen Sulphate, Chlorine, Ammonia and sulfur.				
		3) Avoid storing in sun light and falling of dew.				
		4) Do not use capacitors under high humidity and high and low atmospheric pressure which may affect capacitors reliability.				
		1-2. Handling in transportation In case of the transportation of the capacitors, the performance of the capacitors may be deteriorated depending on the transportation condition. (Refer to JEITA RCR-2335B 9.2 Handling in transportation)				
2	Circuit design A Caution	2-1. Operating temperature Operating temperature should be followed strictly within this specification, especially be careful with maximum temperature.				
		1) Do not use capacitors above the maximum allowable operating temperature.				
		2) Surface temperature including self heating should be below maximum operating temperature.				
		(Due to dielectric loss, capacitors will heat itself when AC is applied. Especially at high frequencies around its SRF, the heat might be so extreme that it may damage itself or the product mounted on. Please design the circuit so that the maximum temperature of the capacitors including the self heating to be below the maximum allowable operating temperature. Temperature rise at capacitor surface shall be below 20°C)				
		 The electrical characteristics of the capacitors will vary depending on the temperature. The capacitors should be selected and designed in taking the temperature into consideration. 2-2. Operating voltage 				
		1) Operating voltage across the terminals should be below the rated voltage. When AC and DC are super imposed, V _{0-P} must be below the rated voltage. ———————————————————————————————————				
		AC or pulse with overshooting, V _{P-P} must be below the rated voltage. ———— (3), (4) and (5)				
	When the voltage is started to apply to the circuit or it is stopped applying, the irregular voltage may be generated for a transit period because of resonance or switching. Be sure to use the capacitors within rated voltage containing these Irregular voltage.					
		Voltage (1) DC voltage (2) DC+AC voltage (3) AC voltage				
		Positional Measurement (Rated voltage) 0 V _{0-P} 0				
		Voltage (4) Pulse voltage (A) (5) Pulse voltage (B)				
		Positional Measurement (Rated voltage) V _{P-P} 0				



No.	Process	Condition
2	Circuit design	2) Even below the rated voltage, if repetitive high frequency AC or pulse is applied, the reliability of the capacitors may be reduced.
	_	The effective capacitance will vary depending on applied DC and AC voltages. The capacitors should be selected and designed in taking the voltages into consideration.
		2-3. Frequency When the capacitors (Class 2) are used in AC and/or pulse voltages, the capacitors may vibrate themselves and generate audible sound.
3	Designing Alumina Substrate	The amount of glue at the terminations has a direct effect on the reliability of the capacitors. 1) The greater the amount of glue with low thickness of land, the higher risk of electrical connection by conductive glue. Design of land and the amount of glue must be considered well.
		Avoid using common land for multiple terminations and provide individual land for each terminations.
4	Mounting	 4-1. Stress from mounting head 1) If the mounting head is adjusted too low, it may induce excessive stress in the chip capacitor to result in cracking. Please take following precautions. 2) Adjust the bottom dead center of the mounting head to reach on the Alumina substrate surface and not press it. 3) Adjust the mounting head pressure to be 1 to 3N of static weight. 4-2. Amount of conductive glue Excessive glue will make a electrical connection under the chip. In sufficient glue may detach the capacitor from the Alumina substrate. Excessive glue will make a electrical connection will be made under the chip.
		Insufficient glue Low robustness may cause contact failure or chip capacitor comes off the Alumina substrate.

No.	Process	Condition
5	Coating and molding of the Alumina substrate	 When the Alumina substrate is coated, please verify the quality influence on the product. Please verify carefully that there is no harmful decomposing or reaction gas emission during curing which may damage the chip capacitors.
		Please verify the curing temperature.
6	Handling of loose chip capacitors	1) If dropped the chip capacitors may crack. Once dropped do not use it. Especially, the large case sized chip capacitors are tendency to have cracks easily, so please handle with care. Floor 2) Piling the Alumina substrate after mounting for storage or handling, the corner of the Alumina substrate may hit the chip capacitors of another board to cause crack. P.C.board Crack
7	Capacitance aging	The capacitors (Class 2) have aging in the capacitance. They may not be used in precision time constant circuit. In case of the time constant circuit, the evaluation should be done well.
8	Estimated life and estimated failure rate of capacitors	As per the estimated life and the estimated failure rate depend on the temperature and the voltage. This can be calculated by the equation described in JEITA RCR-2335B Annex 6 (Informative) Calculation of the estimated life time and the estimated failure rate. (Voltage acceleration coefficient: 3 multiplication rule, Temperature acceleration coefficient: 10°C rule) The failure rate can be decreased by reducing the temperature and the voltage but they will not be guaranteed.

		Condition
9	Others ⚠ Caution	The products listed on this specification sheet are intended for use in general electronic equipment (AV equipment, telecommunications equipment, home appliances, amusement equipment, computer equipment, personal equipment, office equipment, measurement equipment, industrial robots) under a normal operation and use condition.
		The products are not designed or warranted to meet the requirements of the applications listed below, whose performance and/or quality require a more stringent level of safety or reliability, or whose failure, malfunction or trouble could cause serious damage to society, person or property. Please understand that we are not responsible for any damage or liability caused by use of the products in any of the applications below or for any other use exceeding the range or conditions set forth in this specification sheet. If you intend to use the products in the applications listed below or if you have special requirements exceeding the range or conditions set forth in this specification, please contact us.
		 (1) Aerospace/Aviation equipment (2) Transportation equipment (cars, electric trains, ships, etc.) (3) Medical equipment (4) Power-generation control equipment (5) Atomic energy-related equipment (6) Seabed equipment (7) Transportation control equipment (8) Public information-processing equipment (9) Military equipment (10) Electric heating apparatus, burning equipment (11) Disaster prevention/crime prevention equipment (12) Safety equipment (13) Other applications that are not considered general-purpose applications, you are
		kindly requested to take into consideration securing protection circuit/device or providing backup circuits in your equipment.



11. Packaging label

Packaging shall be done to protect the components from the damage during transportation and storing, and a label which has the following information shall be attached.

- 1) Inspection No.
- 2) TDK P/N
- 3) Customer's P/N
- 4) Quantity

*Composition of Inspection No.

Example
$$\underline{F}$$
 $\underline{2}$ \underline{A} \underline{OO} \underline{OOO} (a) (b) (c) (d) (e)

- a) Line code
- b) Last digit of the year
- c) Month and A for January and B for February and so on. (Skip I)
- d) Inspection Date of the month.
- e) Serial No. of the day

12. Bulk packaging quantity

Total number of components in a plastic bag for bulk packaging : 1,000pcs. As for CGA2 types, not available for bulk packaging.



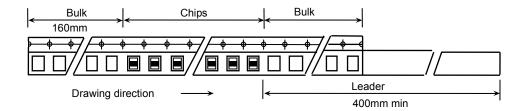
13. TAPE PACKAGING SPECIFICATION

1. CONSTRUCTION AND DIMENSION OF TAPING

1-1. Dimensions of carrier tape

Dimensions of paper tape shall be according to Appendix 2, 3. Dimensions of plastic tape shall be according to Appendix 4.

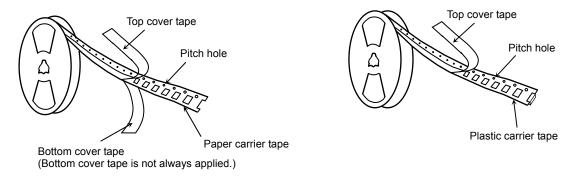
1-2. Bulk part and leader of taping



1-3. Dimensions of reel

Dimensions of Ø178 reel shall be according to Appendix 5, 6. Dimensions of Ø330 reel shall be according to Appendix 7, 8.

1-4. Structure of taping



2. CHIP QUANTITY

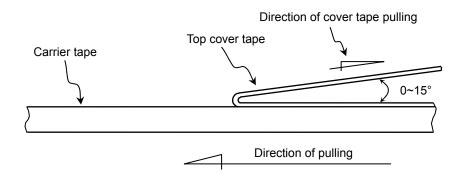
Type	Thickness	Taping	Chip quantity(pcs.)		
туре	of chip	Material	φ178mm reel	φ330mm reel	
CGA2 (CC0402)	0.50 mm	Paper	10,000	50,000	
CGA3 (CC0603)	I U XU mm I Paner or		4,000	10,000	
CGA4	0.85 mm	Paper or Plastic	4,000	10,000	
(CC0805)	1.25 mm	Plastic	2,000	10,000	
CCAE	0.85 mm	Paper or Plastic	4,000	10.000	
CGA5 (CC1206)	1.15 mm	Plastic	2,000	10,000	
(CC1200)	1.60 mm	Flasiic	2,000	8,000	
0046	1.60 mm		2,000	8,000	
CGA6 (CC1210)	2.00 mm	Plastic	1,000	5 000	
(001210)	2.50 mm		1,000	5,000	



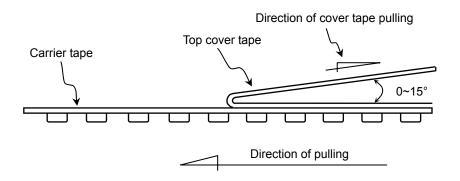
3. PERFORMANCE SPECIFICATIONS

3-1. Fixing peeling strength (top tape)0.05-0.7N. (See the following figure.)

TYPE 1 (Paper)

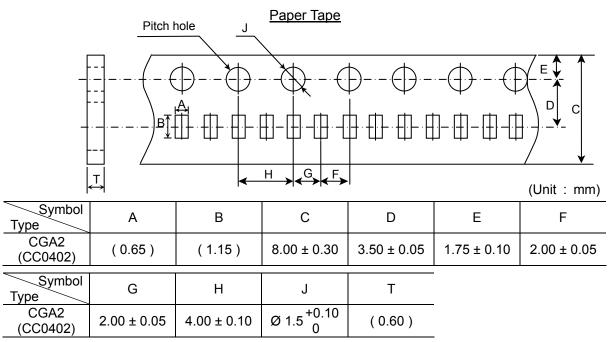


TYPE 2 (Plastic)



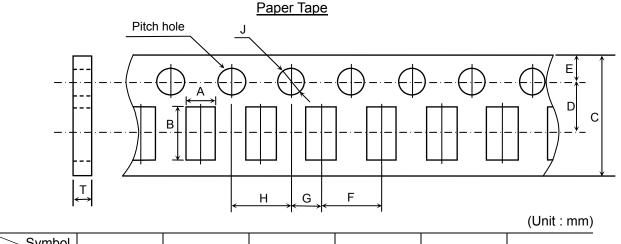
- 3-2. Carrier tape shall be flexible enough to be wound around a minimum radius of 30mm with components in tape.
- 3-3. The missing of components shall be less than 0.1%
- 3-4. Components shall not stick to fixing tape.
- 3-5. The fixing tapes shall not protrude beyond the edges of the carrier tape not shall cover the sprocket holes.





^{*} The values in the parentheses () are for reference.

Appendix 3



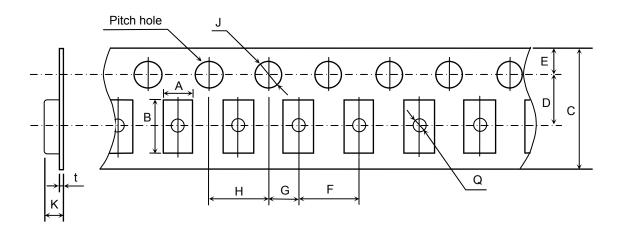
CGA3 (CC0603) (1.10) (1.90) CGA4 (CC0805) (1.50) (2.30) CGA5 (CC1206) (1.90) (3.50) 8.00 ± 0.30 3.50 ± 0.05 1.75 ± 0.10 4.00 ± 0.10	Symbol Type	Α	В	С	D	E	F
(CC0805) (1.50) (2.30) 8.00 ± 0.30 3.50 ± 0.05 1.75 ± 0.10 4.00 ± 0.10		(1.10)	(1.90)				
1 (100) 1 (360) 1		(1.50)	(2.30)	8.00 ± 0.30	3.50 ± 0.05	1.75 ± 0.10	4.00 ± 0.10
		(1.90)	(3.50)				

Symbol Type	G	Н	J	Т
CGA3 (CC0603) CGA4 (CC0805) CGA5 (CC1206)	2.00 ± 0.05	4.00 ± 0.10	Ø 1.5 ^{+0.10}	1.20 max.

^{*} The values in the parentheses () are for reference.



Plastic Tape



(Unit:mm)

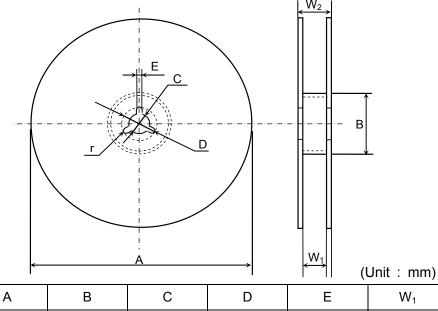
Symbol Type	А	В	С	D	E	F
CGA3 (CC0603)	(1.10)	(1.90)				
CGA4 (CC0805)	(1.50)	(2.30)	8.00 ± 0.30	3.50 ± 0.05	1.75 ± 0.10	4.00 ± 0.10
CGA5 (CC1206)	(1.90)	(3.50)	[12.0 ± 0.30]	[5.50 ± 0.05]	1.73 ± 0.10	4.00 1 0.10
CGA6 (CC1210)	(2.90)	(3.60)				
Symbol	0					
Type	G	Н	J	K	t	Q
CGA3 (CC0603)	G	Н	J	1.50 max.	t	Q
CGA3			10.10	1.50 max.		
CGA3 (CC0603) CGA4	2.00 ± 0.05	H 4.00 ± 0.10			0.60 max.	Q Ø 0.50 min.

 $^{^{\}star}$ The values in the parentheses ($\,\,$) are for reference.



^{*} As for 2.5mm thickness products, apply values in the brackets [].

CGA2, CGA3, CGA4, CGA5, CGA6 (As for CGA6 type, any thickness of the item except 2.5mm) (Material : Polystyrene)

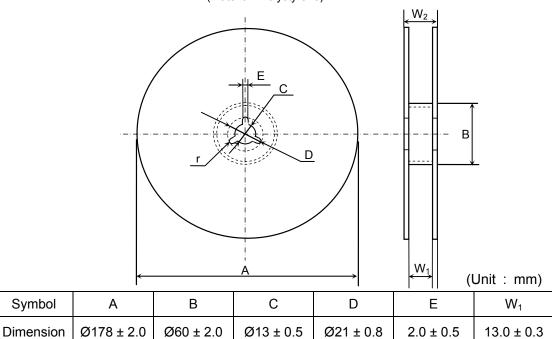


Symbol	Α	В	С	D	Е	W_1
Dimension	Ø178 ± 2.0	Ø60 ± 2.0	Ø13 ± 0.5	Ø21 ± 0.8	2.0 ± 0.5	9.0 ± 0.3

Symbol	W ₂	r
Dimension	13.0 ± 1.4	1.0

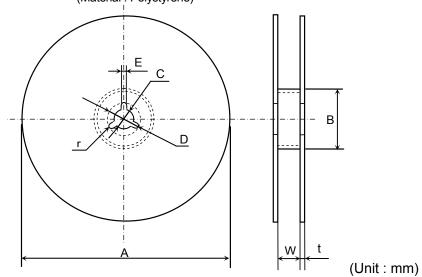
Appendix 6

CGA6 (As for CGA6 type, applied to 2.5mm thickness products) (Material : Polystyrene)



Symbol	W ₂	r
Dimension	17.0 ± 1.4	1.0

CGA2, CGA3, CGA4, CGA5, CGA6 (As for CGA6 type, any thickness of the item except 2.5mm) (Material : Polystyrene)

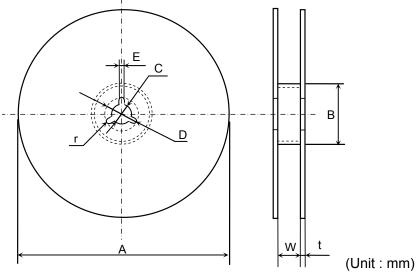


Symbol	А	В	С	D	E	W
Dimension	Ø382 max. (Nominal Ø330)	Ø50 min.	Ø13 ± 0.5	Ø21 ± 0.8	2.0 ± 0.5	10.0 ± 1.5

Symbol	t	r
Dimension	2.0 ± 0.5	1.0

Appendix 8

CGA6 (As for CGA6 type, applied to 2.5mm thickness products) (Material : Polystyrene)



Symbol	Α	В	С	D	E	W
Dimension	Ø382 max. (Nominal Ø330)	Ø50 min.	Ø13 ± 0.5	Ø21 ± 0.8	2.0 ± 0.5	14.0 ± 1.5

Symbol	t	r
Dimension	2.0 ± 0.5	1.0